## 1. General description

Trench Schottky barrier rectifier encapsulated in a CFP15B (SOT1289B) power and flat lead Surface-Mounted Device (SMD) plastic package.

#### 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 10 A
- Reverse voltage: V<sub>R</sub> ≤ 45 V
- · Extremely low forward voltage
- · High power capability due to clip-bonding technology and heat sink
- Small and thin SMD power plastic package, typical height 0.95 mm
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

- Low voltage rectification
- · High efficiency DC-to-DC conversion
- · Switch mode power supply
- Freewheeling application
- Reverse polarity protection
- Low power consumption application

#### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	-	45	V
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; $T_{sp} \le 142 ^{\circ}\text{C}$		-	-	10	А
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 10 A; T <sub>j</sub> = 25 °C; pulsed	[1]	-	480	545	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 10 V; T <sub>j</sub> = 25 °C; pulsed	[1]	-	11	41	μΑ
		$V_R = 45 \text{ V}; T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$	[1]	-	22	80	μΑ

[1] Very short pulse, in order to maintain a stable junction temperature.



# 5. Pinning information

#### **Table 2. Pinning information**

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A	anode	5	
2	A	anode		K A
3	K	cathode	2	aaa-009063
			CFP15B (SOT1289B)	

# 6. Ordering information

#### **Table 3. Ordering information**

Type number	Package						
	Name	Description	Version				
PMEG045T100EPE-Q		plastic, thermal enhanced ultra thin SMD package; 3 leads; 2.13 mm pitch; 5.8 x 4.3 x 0.95 mm body	SOT1289B				

# 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PMEG045T100EPE-Q	045T M10E

# 8. Limiting values

#### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	T <sub>j</sub> = 25 °C		-	45	V
I <sub>F</sub>	forward current	δ = 1; T <sub>sp</sub> ≤ 137 °C		-	14	А
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; $T_{sp} \le 142 ^{\circ}\text{C}$		-	10	Α
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8 ms; square wave; $T_{j(init)}$ = 25 °C		-	130	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	1.66	W
			[2]	-	2.15	W
Tj	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

<sup>[1]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

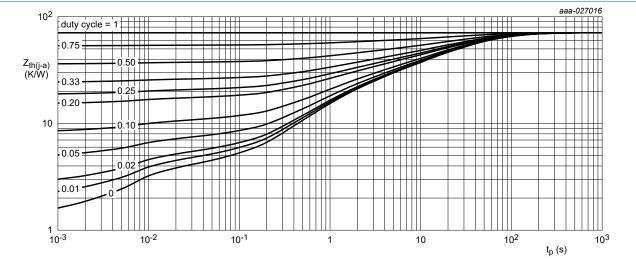
Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

# 9. Thermal characteristics

**Table 6. Thermal characteristics** 

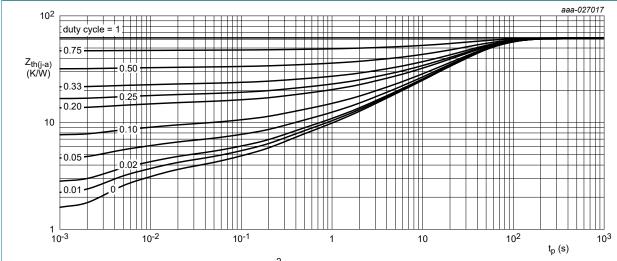
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from	in free air	[1] [2]	-	-	90	K/W
jui	junction to ambient		[1] [3]	-	-	70	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[4]	-	-	3	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

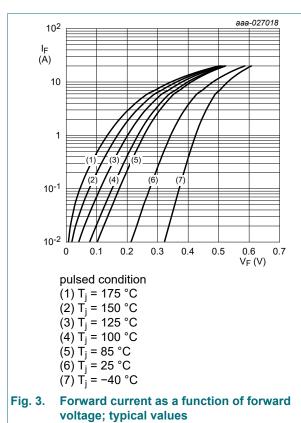
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

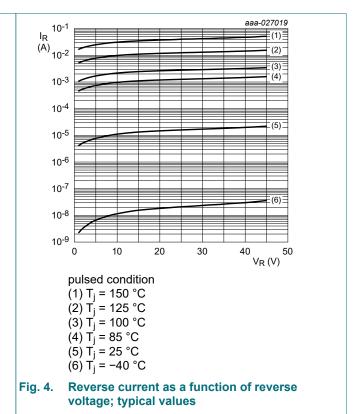
### 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R = 1 \text{ mA}$ ; pulsed; $T_j = 25 \text{ °C}$	[1]	45	-	-	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 0.1 A; T <sub>j</sub> = 25 °C; pulsed	[1]	-	275	-	mV
		I <sub>F</sub> = 1 A; T <sub>j</sub> = 25 °C; pulsed	[1]	-	340	385	mV
		$I_F = 5 \text{ A}; T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$	[1]	-	415	475	mV
		I <sub>F</sub> = 10 A; T <sub>j</sub> = 25 °C; pulsed	[1]	-	480	545	mV
		$I_F = 10 \text{ A}; T_j = -40 ^{\circ}\text{C}; \text{ pulsed}$	[1]	-	530	-	mV
		I <sub>F</sub> = 10 A; T <sub>j</sub> = 125 °C; pulsed	[1]	-	380	-	mV
I <sub>R</sub>	reverse current	V <sub>R</sub> = 10 V; T <sub>j</sub> = 25 °C; pulsed	[1]	-	11	41	μΑ
		$V_R = 30 \text{ V}; T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$	[1]	-	17	-	μΑ
		V <sub>R</sub> = 45 V; T <sub>j</sub> = 25 °C; pulsed	[1]	-	22	80	μΑ
		V <sub>R</sub> = 45 V; T <sub>j</sub> = 125 °C; pulsed	[1]	-	15	-	mA
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C		-	1.4	-	nF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C		-	0.6	-	nF
t <sub>rr</sub>	reverse recovery time step recovery	$I_F = 0.5 \text{ A}; I_R = 0.5 \text{ A}; I_{R(meas)} = 0.1 \text{ A};$ $T_j = 25 ^{\circ}\text{C}$		-	40	-	ns
	reverse recovery time ramp recovery	$dI_F/dt = 200 \text{ A/}\mu\text{s}; I_F = 6 \text{ A}; T_j = 25 ^{\circ}\text{C}$		-	20	-	ns

[1] Very short pulse, in order to maintain a stable junction temperature.





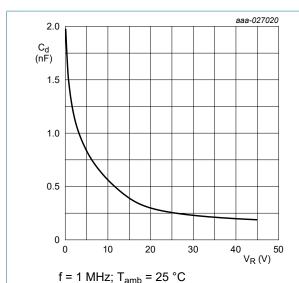
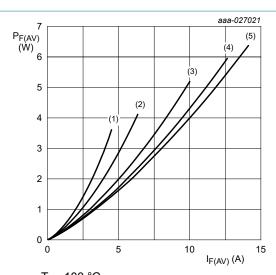
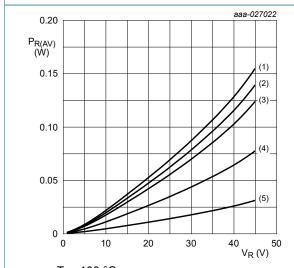


Fig. 5. Diode capacitance as a function of reverse voltage; typical values



 $T_i = 100 \, ^{\circ}C$  $(1) \delta = 0.1$  $(2) \delta = 0.2$  $(3) \delta = 0.5$  $(4) \delta = 0.8$ (5)  $\delta$  = 1; DC

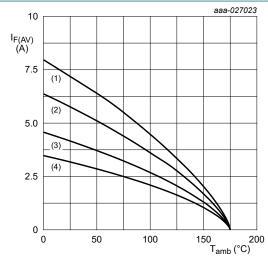
Average forward power dissipation as a Fig. 6. function of average forward current; typical values



T<sub>i</sub> = 100 °C  $(1) \delta = 1$ ; DC  $(2) \delta = 0.9$ 

 $(3) \delta = 0.8$  $(4) \delta = 0.5$  $(5) \delta = 0.2$ 

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



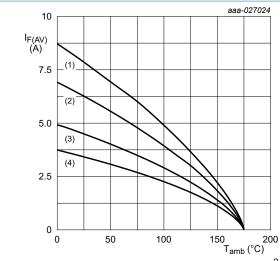
FR4 PCB, standard footprint

T<sub>i</sub> = 175 °C  $(1) \delta = 1$ ; DC (2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Average forward current as a function of Fig. 8. ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

 $T_i = 175 \,{}^{\circ}\text{C}$ 

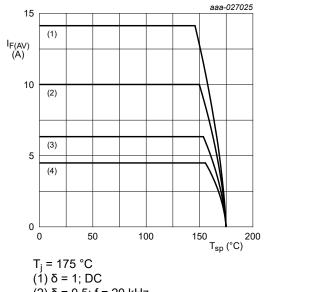
 $(1) \delta = 1$ ; DC

(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Average forward current as a function of Fig. 9. ambient temperature; typical values



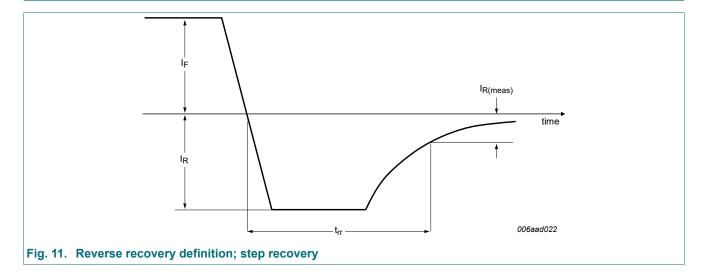
(2)  $\delta = 0.5$ ; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

 $(4) \delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

### 11. Test information



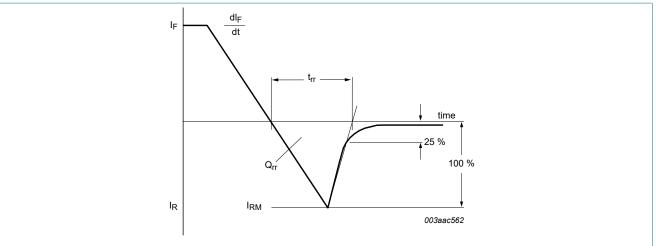


Fig. 12. Reverse recovery definition; ramp recovery

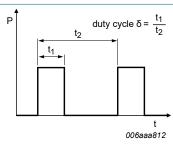


Fig. 13. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,

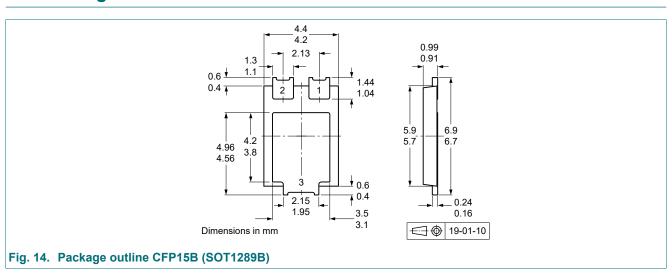
 $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_{M} \times \sqrt{\delta}$ 

with  $I_{\text{RMS}}$  defined as RMS current.

#### **Quality information**

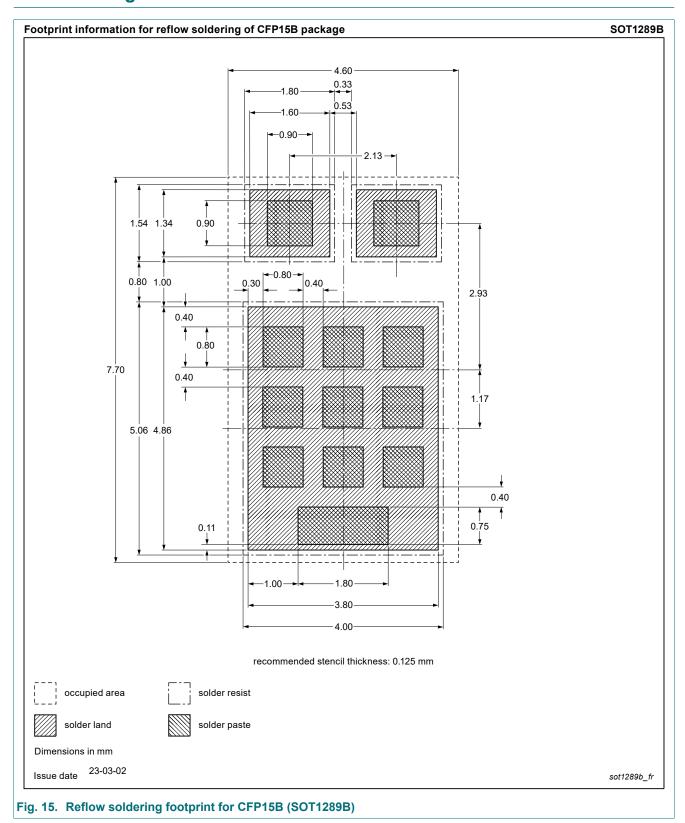
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

# 12. Package outline



PMEG045T100EPE-Q

# 13. Soldering



# 14. Revision history

#### Table 8. Revision history

able 6. Revision history							
Data sheet ID	Release date	Data sheet status	Change notice	Supersedes			
PMEG045T100EPE-Q v.3	20240715	Product data sheet	-	PMEG045T100EPE-Q v.2			
Modifications:	Reflow soldering foo	Reflow soldering footprint: Stencil design for solder paste printing changed.					
PMEG045T100EPE-Q v.2	20210507	Product data sheet	-	PMEG045T100EPE-Q v.1			
PMEG045T100EPE-Q v.1	20210303	Product data sheet	-	-			

## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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### 45 V, 10 A low VF Trench Schottky barrier rectifier

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